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PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

Confirmation No.: 7113

Yuichi INADA et al.

Art Unit: 1722

Application No.: 10/534,488

Examiner: Dimple N. Bodawala

Filed: May 11, 2005

Attorney Dkt. No.: 059559.00020

For: MOLDING DIE, MOLDING METHOD, DISC SUBSTRATE, AND MOLDING MACHINE

RESPONSE UNDER 37 CFR § 1.111

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

July 10, 2007

Sir:

In response to the Office Action dated April 18, 2007, please amend the above-identified application as set forth below.

Amendments to the claims are submitted beginning on page 2.

Remarks are submitted beginning on page 6.